

PLEASE CHECK WWW.MOLEX.COM FOR LATEST PART INFORMATION

Part Number: [0753310464](#)
Status: **Active**
Overview: [gbx_backplane_connector_system](#)
Description: 1.85mm by 1.85mm (.073 by .073") Pitch 3-Pair GbX® Backplane Connector System, Power Module, 6 Circuits, 1.27µm (50µ") Gold (Au)

Documents:

[Drawing \(PDF\)](#) [RoHS Certificate of Compliance \(PDF\)](#)
[Product Specification PS-75221-999 \(PDF\)](#)

Agency Certification

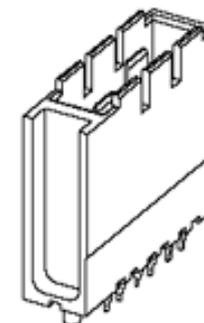
UL E29179

General

Product Family Backplane Connectors
 Series [75331](#)
 Application Backplane
 Application Tooling Documents [Tooling Manual](http://www.molex.com/pdm_docs/ats/TM-622022099.pdf)
 Comments Blade Length A 4.50mm, B 6.00mm, C 4.50mm
 Component Type Power Header
 Overview [gbx_backplane_connector_system](#)
 Product Name GbX®
 Style N/A

Physical

Circuits (Loaded) 6
 Circuits (maximum) 6
 Circuits Detail Rows A, B & C
 Color - Resin Gray (Dark)
 Durability (mating cycles max) 200
 First Mate / Last Break Yes
 Flammability 94V-0
 Guide to Mating Part No
 Keying to Mating Part None
 Material - Metal High Performance Alloy (HPA)
 Material - Plating Mating Gold
 Material - Plating Termination Tin-Lead
 Material - Resin High Temperature Thermoplastic
 Number of Columns N/A
 Number of Pairs 3
 Number of Rows 3
 Orientation Vertical
 PC Tail Length (in) 0.090 In
 PC Tail Length (mm) 2.28 mm
 PCB Locator Yes
 PCB Retention Yes
 PCB Thickness Recommended (in) 0.063 In
 PCB Thickness Recommended (mm) 1.60 mm
 Packaging Type Tube
 Pitch - Mating Interface (in) 0.000 In
 Pitch - Mating Interface (mm) 0.00 mm
 Pitch - Term. Interface (in) 0.102 In
 Pitch - Term. Interface (mm) 2.60 mm
 Plating min: Mating (µin) 50
 Plating min: Mating (µm) 1.25



Series
image - Reference only

EU RoHS

RoHS Compliant by Exemption

REACH SVHC

Contains SVHC: No

Halogen-Free

Status

Halogen-Free

China RoHS



Pb

Need more information on product environmental compliance?

Email productcompliance@molex.com
 For a multiple part number RoHS Certificate of Compliance, [click here](#)

Please visit the [Contact Us](#) section for any non-product compliance questions.

Search Parts in this Series

[75331Series](#)

Mates With

[75292 GbX® Daughtercard](#)

Application Tooling | FAQ

Tooling specifications and manuals are found by selecting the products below. Crimp Height Specifications are then contained in the Application Tooling Specification document.

Global

Description	Product #
GbX® Single Pin Repair Tool	0622022090
GbX® Shield Removal Tool	0622022100
GbX® 3 Pair 1-Up Power Module	0622022580

Plating min: Termination (μ in)	30
Plating min: Termination (μ m)	0.75
Polarized to PCB	Yes
Stackable	No
Surface Mount Compatible (SMC)	Yes
Temperature Range - Operating	105°C
Termination Interface: Style	Through Hole - Compliant Pin

Electrical

Current - Maximum per Contact	6A
Data Rate	8.0 Gbps
Real Signals (per 25mm)	0
Shield Type	N/A
Shielded	No
Voltage - Maximum	120V AC (RMS)/DC

Material Info

Reference - Drawing Numbers

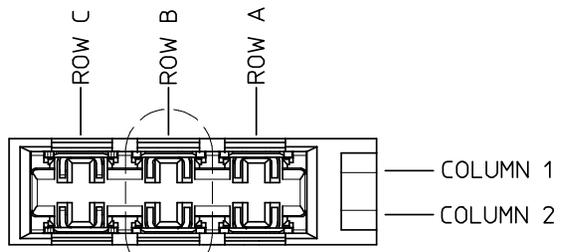
Packaging Specification	PK-70873-571
Product Specification	PS-75221-999
Sales Drawing	SD-75331-001

GbX is a registered trademark of Amphenol Corporation.

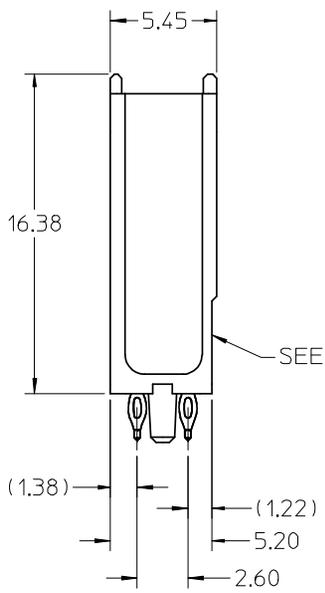
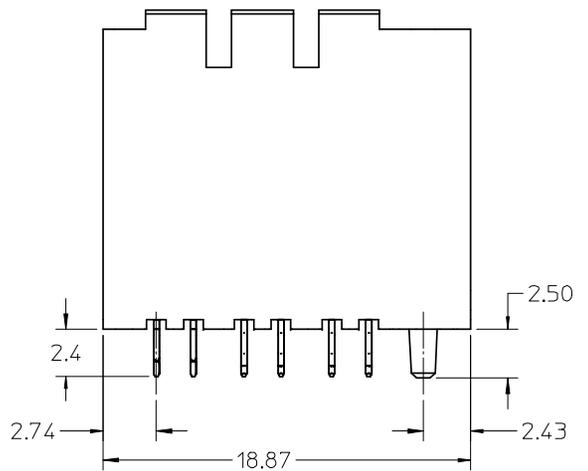
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10 9 8 7 6 5 4 3 2 1

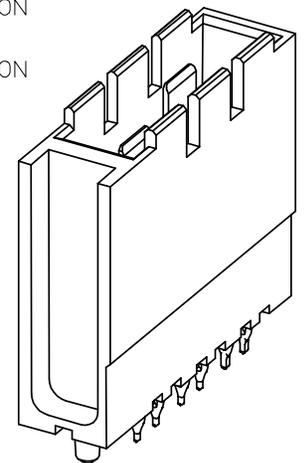


SEE NOTE 4.



SEE NOTE 8.

- NOTES:
1. MATERIALS: HOUSING - LIQUID CRYSTAL POLYMER (LCP), UL 94V-0, GRAY; CONTACT - COPPER ALLOY.
 2. FINISH: SELECT GOLD IN CONTACT AREA, 50 μ " THICK, TIN/LEAD OR MATTE TIN IN COMPLIANT AREA.
 3. PACKAGING PER PK-70873-571.
 4. CONTACTS IN EACH ROW HAVE THE SAME WIPE LENGTH.
 5. BACKPLANE ASSEMBLY MATES WITH DAUGHTERCARD POWER MODULE 75292-3***.
 6. PART SHOWN IS 75331-0467.
 7. SEE OTHER SHEETS FOR ADDITIONAL NOTES.
 8. WHEN INSERTING OPEN SIGNAL MODULES NEXT TO COLUMN 1 SIDE OF POWER MODULES, SIGNAL MODULES MUST BE INSERTED BEFORE THE POWERS TO AVOID INTERFERENCE BETWEEN THE TWO CONNECTOR HOUSINGS.
 9. THESE PARTS CONFORM TO MOLEX PRODUCT SPECIFICATION PS-75221-999.
 10. THESE PARTS CONFORM TO MOLEX COSMETIC SPECIFICATION PS-45499-002.



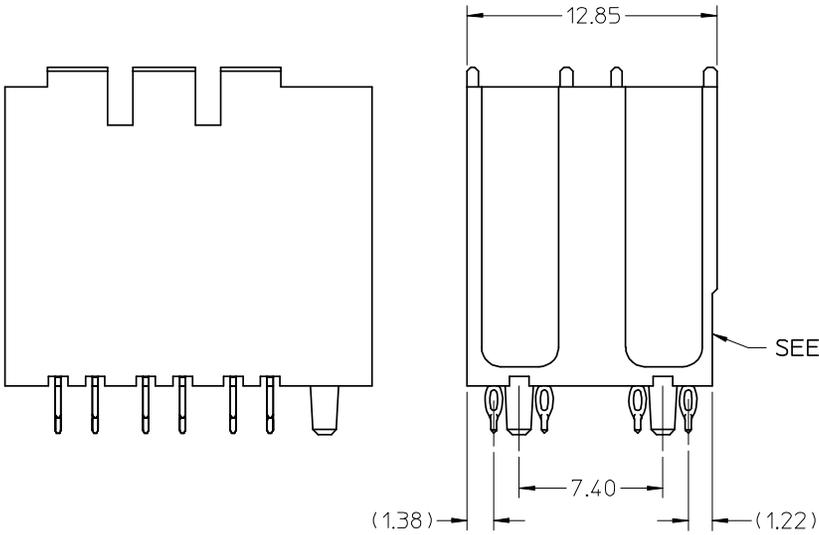
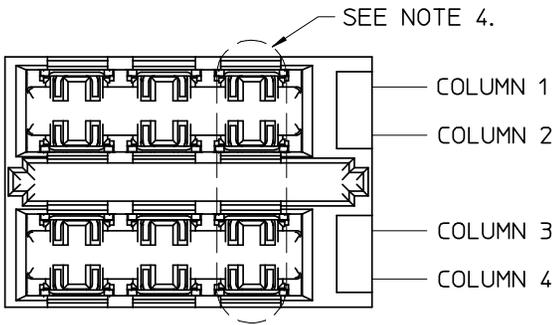
1-UP ASSEMBLY PART NUMBER

7 5 3 3 1 - 0 A B C
 - TIN/LEAD PLATED PRODUCT -
 FOR EACH ROW LOCATION A, B, C:
 0 = VOID
 4 = 4.5 mm WIPE
 6 = 6.0 mm WIPE
 7 = 7.5 mm WIPE
 - LEAD-FREE PLATED PRODUCT -
 FOR EACH ROW LOCATION A, B, C:
 0 = VOID
 2 = 4.5 mm WIPE
 3 = 6.0 mm WIPE
 5 = 7.5 mm WIPE

SPEC FILE CORRECTED EC NO: UCP2008-2380 TIDR/MND/AVARVA 2008/03/27 CHKD: JBINGHAM 2008/03/27 APPR: JBINGHAM 2008/03/31	QUALITY SYMBOLS	GENERAL TOLERANCES (UNLESS SPECIFIED)	DIMENSION STYLE	SCALE	DESIGN UNITS	THIRD ANGLE PROJECTION	
	▽=0 ▽=0	mm INCH 4 PLACES ±--- ±--- 3 PLACES ±--- ±--- 2 PLACES ±--- ±--- 1 PLACE ±--- ±--- ANGULAR ±---°	MM ONLY	4:1	METRIC	DRAWN BY DATE ELO 2005/02/18 CHECKED BY DATE ELO 2005/02/22 APPROVED BY DATE CUNNINGHAM 2005/02/23 MATERIAL NO.	TITLE GBX 3 PAIR BACKPLANE POWER SALES ASSEMBLY MOLEX MOLEX INCORPORATED DOCUMENT NO. SD-75331-001
	DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS	SEE CHART	THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION	SHEET NO. 1 OF 4			
	REV	DESCRIPTION					

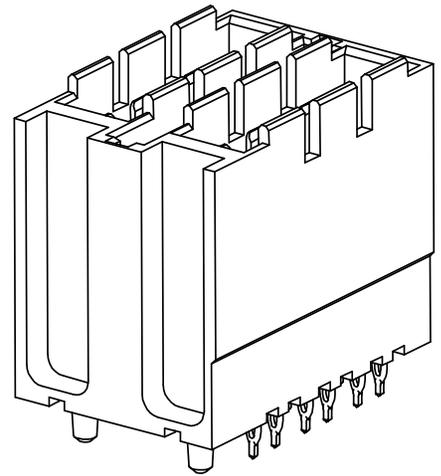
9 8 7 6 5 4 3 2 1

10 9 8 7 6 5 4 3 2 1



2-UP ASSEMBLY PART NUMBER

7 5 3 3 2 - 0 A B C
 - TIN/LEAD PLATED PRODUCT -
 FOR EACH ROW LOCATION A, B, C:
 0 = VOID
 4 = 4.5 mm WIPE
 6 = 6.0 mm WIPE
 7 = 7.5 mm WIPE
 - LEAD-FREE PLATED PRODUCT -
 FOR EACH ROW LOCATION A, B, C:
 0 = VOID
 2 = 4.5 mm WIPE
 3 = 6.0 mm WIPE
 5 = 7.5 mm WIPE

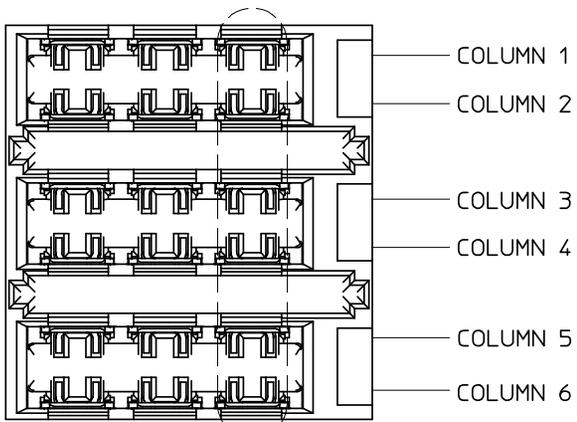


SEE SHEET 1 FOR ADDITIONAL INFORMATION
 CHECK WITH PRODUCT MANAGER FOR AVAILABILITY

SEE SHEET ONE EC NO: UCP2008-2380 TDR: DWARVARA 2008/03/27 CHKD: BINGHAM 2008/03/27 APPR: BINGHAM 2008/03/31	QUALITY SYMBOLS ▽=0 ▽=0	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE 4:1	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION		
			mm	INCH	DRAWN BY ELO	DATE 2005/02/18	TITLE GBX 3 PAIR BACKPLANE POWER SALES ASSEMBLY MOLEX INCORPORATED			
		4 PLACES	±---	±---	CHECKED BY ELO	DATE 2005/02/22				
		3 PLACES	±---	±---	APPROVED BY CUNNINGHAM	DATE 2005/02/23	DOCUMENT NO. SD-75331-001		SHEET NO. 2 OF 4	
2 PLACES	±---	±---	DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		SEE CHART		THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION			
1 PLACE	±---	±---			SIZE B					

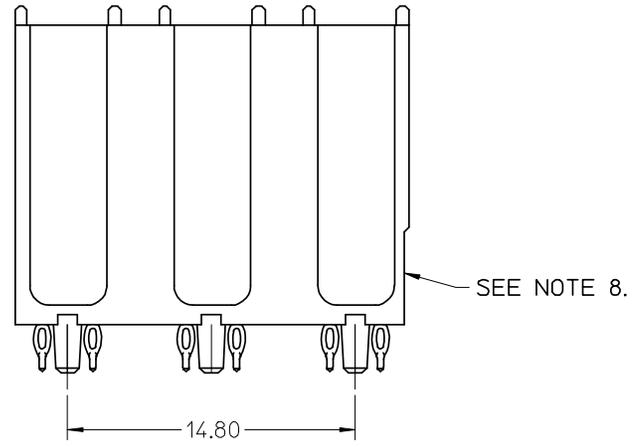
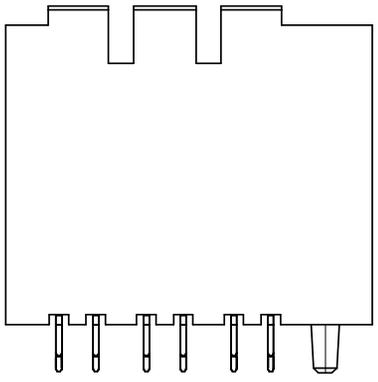
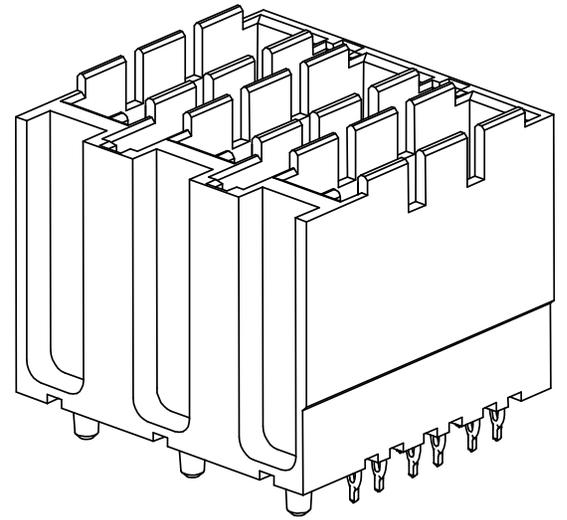
9 8 7 6 5 4 3 2 1

10 9 8 7 6 5 4 3 2 1



3-UP ASSEMBLY PART NUMBER

7 5 3 3 3 - 0 A B C
 - TIN/LEAD PLATED PRODUCT -
 FOR EACH ROW LOCATION A, B, C:
 0 = VOID
 4 = 4.5 mm WIPE
 6 = 6.0 mm WIPE
 7 = 7.5 mm WIPE
 - LEAD-FREE PLATED PRODUCT -
 FOR EACH ROW LOCATION A, B, C:
 0 = VOID
 2 = 4.5 mm WIPE
 3 = 6.0 mm WIPE
 5 = 7.5 mm WIPE



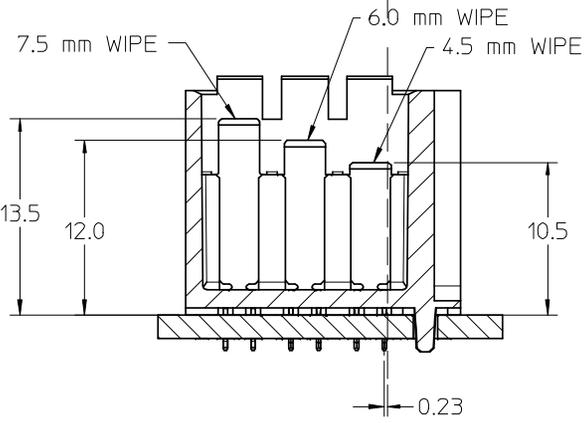
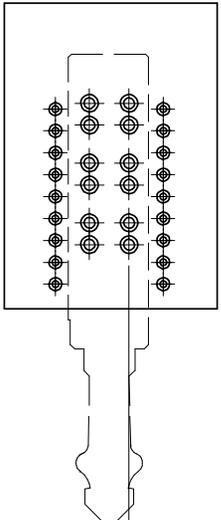
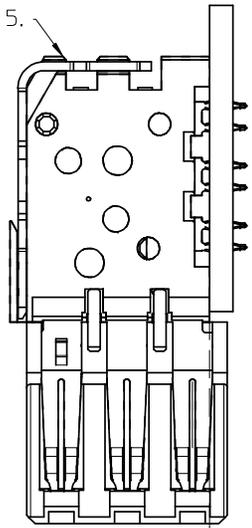
SEE SHEET 1 FOR ADDITIONAL INFORMATION
 CHECK WITH PRODUCT MANAGER FOR AVAILABILITY

SEE SHEET ONE EC NO: UCP2008-2380 TDR: DWARVARA 2008/03/27 CHKD: J. INGHAM 2008/03/27 APPR: J. INGHAM 2008/03/31	REV DESCRIPTION	QUALITY SYMBOLS	GENERAL TOLERANCES (UNLESS SPECIFIED)	DIMENSION STYLE	SCALE	DESIGN UNITS	THIRD ANGLE PROJECTION		
		▼=0 ▽=0	mm INCH 4 PLACES ± --- ± --- 3 PLACES ± --- ± --- 2 PLACES ± --- ± --- 1 PLACE ± --- ± --- ANGULAR ± ---°	MM ONLY	4:1	METRIC	DRAWN BY DATE ELO 2005/02/18 CHECKED BY DATE ELO 2005/02/22 APPROVED BY DATE CUNNINGHAM 2005/02/23 MATERIAL NO.	TITLE GBX 3 PAIR BACKPLANE POWER SALES ASSEMBLY MOLEX INCORPORATED DOCUMENT NO. SD-75331-001	SHEET NO. 3 OF 4
		DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		SEE CHART	THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION				
				SIZE B					

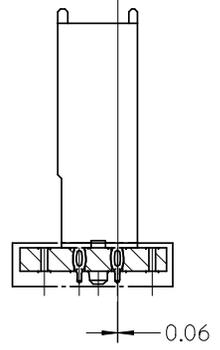
9 8 7 6 5 4 3 2 1

10 9 8 7 6 5 4 3 2 1

SEE NOTE 5.

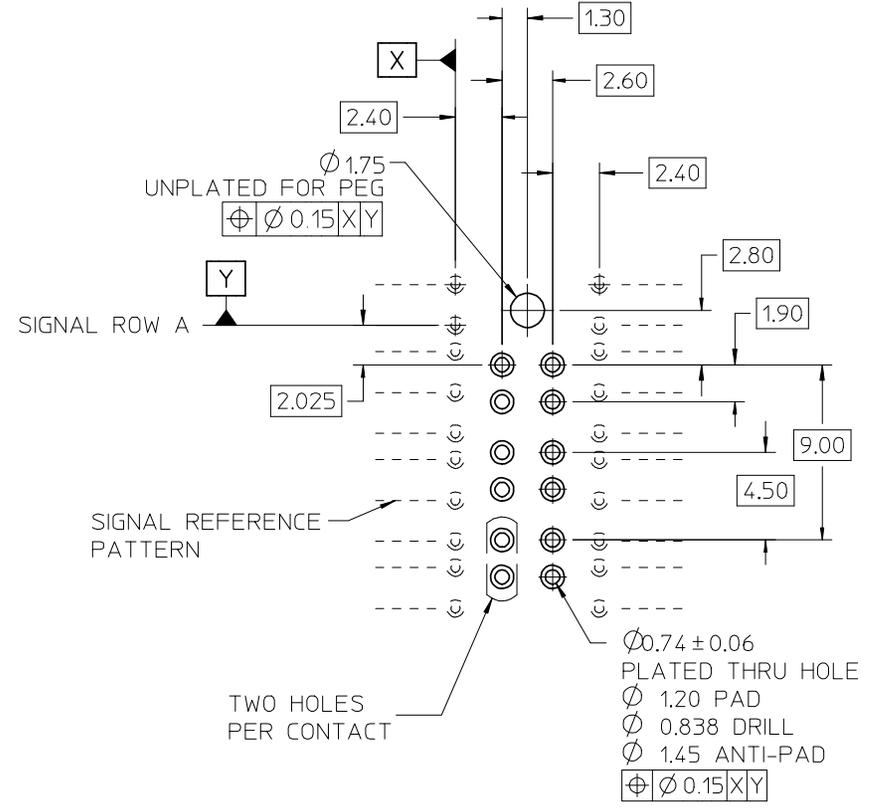


DC BOARD EDGE TO CENTERLINE OF BP TAIL



HOLE PATTERN FOR 1-UP ASSEMBLY

- 1.) ADD 7.40 FROM CENTERLINES OF PEGS FOR MULTIPLE UP ASSEMBLIES.
- 2.) ADD 5.55 FROM CENTERLINE TO CENTERLINE OF PEG FOR INDIVIDUAL POWER MODULES STACKED NEXT TO EACH OTHER.



SEE SHEET ONE EC NO: UCP2008-2380 TDRWN: DIVARVARA 2008/03/27 CHKD: JB INGHAM 2008/03/27 APPR: JB INGHAM 2008/03/31	DESCRIPTION REV	QUALITY SYMBOLS	GENERAL TOLERANCES (UNLESS SPECIFIED) mm INCH 4 PLACES ± --- ± --- 3 PLACES ± --- ± --- 2 PLACES ± --- ± --- 1 PLACE ± --- ± --- ANGULAR ± --- °	DIMENSION STYLE	SCALE	DESIGN UNITS	THIRD ANGLE PROJECTION GBX 3 PAIR BACKPLANE POWER SALES ASSEMBLY MOLEX INCORPORATED SD-75331-001
		MM ONLY		4:1	METRIC		
		DRAWN BY		DATE	TITLE		
		ELO		2005/02/18			
CHECKED BY	DATE						
ELO	2005/02/22						
APPROVED BY	DATE						
CUNNINGHAM	2005/02/23						
MATERIAL NO.	DOCUMENT NO.						
SEE PREVIOUS							
SIZE B	THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION		SHEET NO. 4 OF 4				

9 8 7 6 5 4 3 2 1

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Вы можете разместить у нас заказ для любого Вашего проекта, будь то серийное производство или разработка единичного прибора.

В нашем ассортименте представлены ведущие мировые производители активных и пассивных электронных компонентов.

Нашей специализацией является поставка электронной компонентной базы двойного назначения, продукции таких производителей как XILINX, Intel (ex.ALTERA), Vicor, Microchip, Texas Instruments, Analog Devices, Mini-Circuits, Amphenol, Glenair.

Сотрудничество с глобальными дистрибьюторами электронных компонентов, предоставляет возможность заказывать и получать с международных складов практически любой перечень компонентов в оптимальные для Вас сроки.

На всех этапах разработки и производства наши партнеры могут получить квалифицированную поддержку опытных инженеров.

Система менеджмента качества компании отвечает требованиям в соответствии с ГОСТ Р ИСО 9001, ГОСТ РВ 0015-002 и ЭС РД 009

Офис по работе с юридическими лицами:

105318, г.Москва, ул.Щербаковская д.3, офис 1107, 1118, ДЦ «Щербаковский»

Телефон: +7 495 668-12-70 (многоканальный)

Факс: +7 495 668-12-70 (доб.304)

E-mail: info@moschip.ru

Skype отдела продаж:

moschip.ru

moschip.ru_4

moschip.ru_6

moschip.ru_9